IPC - ASSOCIATION CONNECTINE ELECTRONICS INDUSTRIES	© Copyright 2005. IPO	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both le	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1					Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				als and Mfg	Informati	ion		
upplier Inform	nation													
Company name*			Company unique ID			U	Unique ID Authority				Response Date*			
onsemi											2024-05-17			
Contact Name			Title - Contact			P	Phone - Contact*				Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
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Product-Env-Stewards			Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
Requeste	er Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	N	Manufacturing Site		eight*	UOM	Unit Type
	2SA2016-TD-E BIP		BIP PNP 7A 50V			2024-05-17 CNG		CNG		82	mg	Each		
	Process Informati		' 1D	A.11	CED 020 May 1	D. C	D 1 D	D 1 T		M T (P. 1	T	N. 1	CD C	,
			*		STD-020 MSL 1	Rating		ak Process Body Temperat					per of Reflow Cyc	eles
contains	Bi	C	U Alloy	1			260		<u> C</u>	30	seconds	3		
omments														
	ime at peak temperatur													
r more informatio	on regarding material co	omposition p	please refer t	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier shall applier be averaged in the certification of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	es per the definition above except for selected exemp	otions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		'Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	astislav Drska	-6_								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.67	mg	Supplier	Silicon (Si)	7440-21-3		0.67	mg
Die Attach Solder	0.31	mg	Supplier	Silver (Ag)	7440-22-4		0.0078	mg
			A	Lead (Pb)	7439-92-1	7a	0.2868	mg
			Supplier	Tin (Sn)	7440-31-5		0.0155	mg
Lead Frame	26.08	mg	Supplier	Silver (Ag)	7440-22-4		0.1069	mg
			Supplier	Tin (Sn)	7440-31-5		0.0365	mg
			Supplier	Copper (Cu)	7440-50-8		25.9366	mg
Mold Compound-Black	26.53	mg		Brominated epoxy resin	proprietary data		0.3714	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		1.1939	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.2388	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2653	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		19.8975	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		4.5101	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.0531	mg
Plating	0.82	mg	В	Bismuth (Bi)	7440-69-9		0.0049	mg
			Supplier	Tin (Sn)	7440-31-5		0.8151	mg
Wire Bond - Au	0.41	mg	Supplier	Gold (Au)	7440-57-5		0.41	mg